

# IS61WV25632ALL/ALS IS61WV25632BLL/BLS IS64WV25632BLL/BLS



## 256K x 32 HIGH-SPEED ASYNCHRONOUS CMOS STATIC RAM WITH 3.3V SUPPLY

PRELIMINARY INFORMATION  
APRIL 2008

### FEATURES

- High-speed access times:  
8, 10, 20 ns
- High-performance, low-power CMOS process
- Multiple center power and ground pins for greater noise immunity
- Easy memory expansion with  $\overline{CE}$  and  $\overline{OE}$  options
- $\overline{CE}$  power-down
- Fully static operation: no clock or refresh required
- TTL compatible inputs and outputs
- Single power supply  
V<sub>DD</sub> 1.65V to 2.2V (IS61WV25632Axx)  
speed = 20ns for V<sub>DD</sub> 1.65V to 2.2V  
V<sub>DD</sub> 2.4V to 3.6V (IS61/64WV25632Bxx)  
speed = 10ns for V<sub>DD</sub> 2.4V to 3.6V  
speed = 8ns for V<sub>DD</sub> 3.3V ± 5%
- Packages available:
  - 90-ball miniBGA (8mm x 13mm)
- Industrial and Automotive Temperature Support
- Lead-free available

### DESCRIPTION

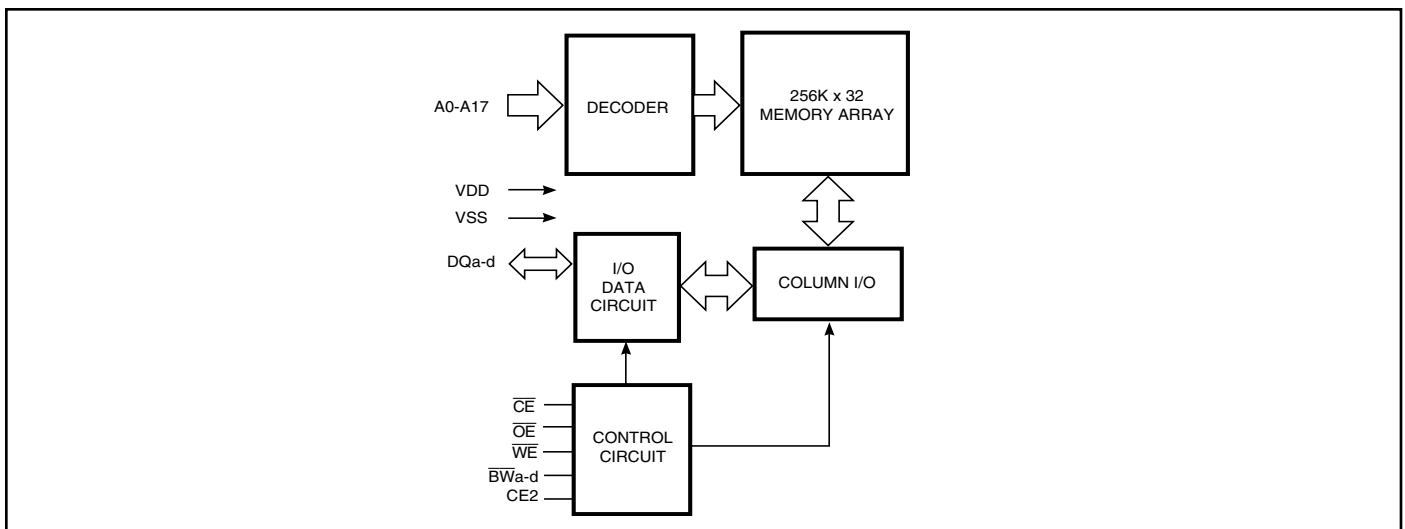
The *ISSI* IS61WV25632Axx/Bxx and IS64WV25632Bxx are high-speed, 8M-bit static RAMs organized as 256K words by 32 bits. It is fabricated using *ISSI*'s high-performance CMOS technology. This highly reliable process coupled with innovative circuit design techniques, yields high-performance and low power consumption devices.

When  $\overline{CE}$  is HIGH (deselected), the device assumes a standby mode at which the power dissipation can be reduced down with CMOS input levels.

Easy memory expansion is provided by using Chip Enable and Output Enable inputs,  $\overline{CE}$  and  $\overline{OE}$ . The active LOW Write Enable ( $\overline{WE}$ ) controls both writing and reading of the memory.

The device is packaged in the JEDEC standard 90-ball BGA (8mm x 13mm).

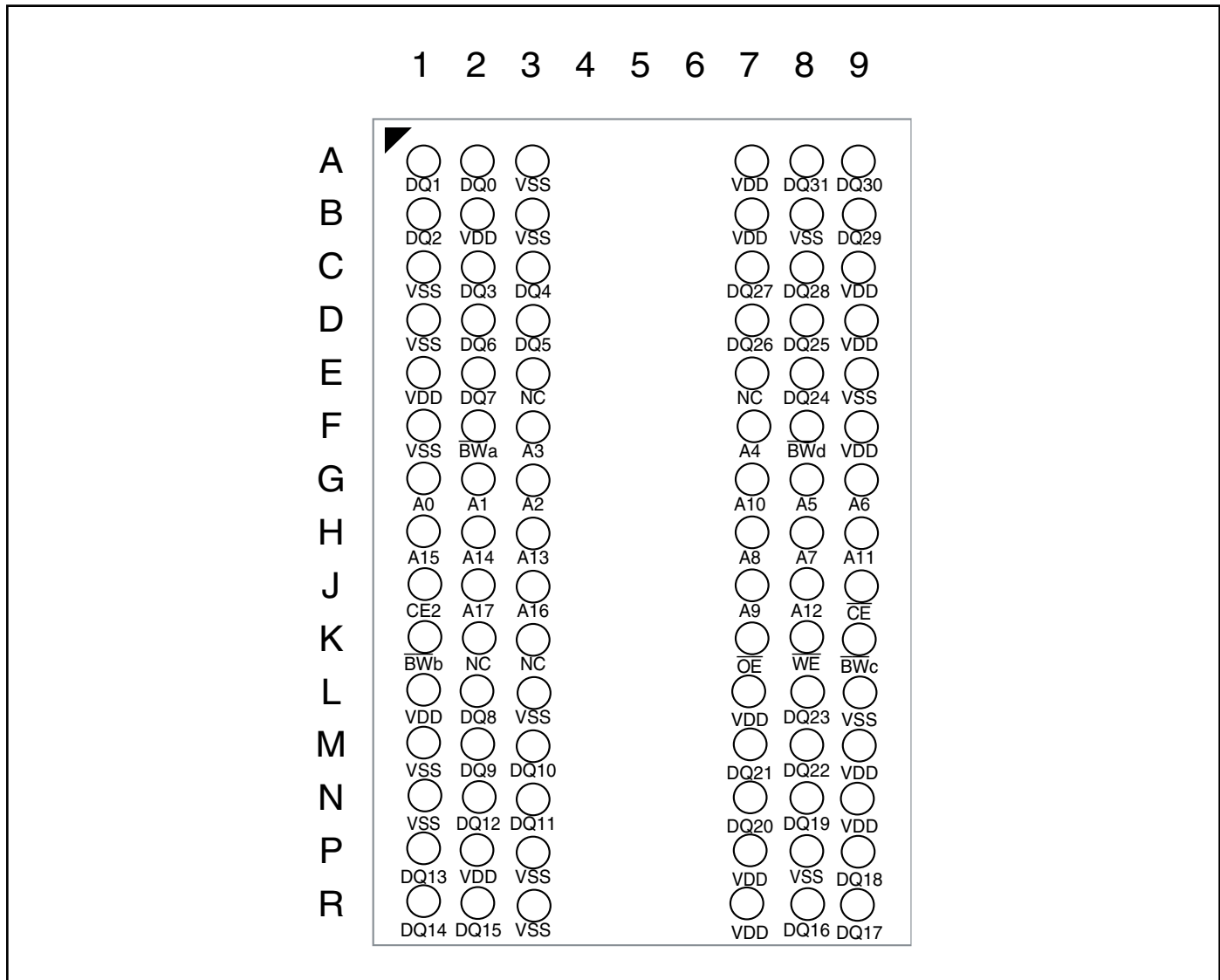
### FUNCTIONAL BLOCK DIAGRAM



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## PIN CONFIGURATION

PACKAGE CODE: B 90 BALL FBGA (Top View) (8.00 mm x 13.00 mm Body, 0.8 mm Ball Pitch)



## PIN DESCRIPTIONS

|                 |                     |
|-----------------|---------------------|
| A0-A17          | Address Inputs      |
| DQx             | Data I/O            |
| CE, CE2         | Chip Enable Input   |
| OE              | Output Enable Input |
| WE              | Write Enable Input  |
| BWx (x=a-d)     | Byte Write Control  |
| V <sub>DD</sub> | Power               |
| V <sub>SS</sub> | Ground              |
| NC              | No Connection       |

## TRUTH TABLE

| CE | CE2 | OE | WE | BW <sub>a</sub> | BW <sub>b</sub> | BW <sub>c</sub> | BW <sub>d</sub> | DQ <sub>0-7</sub> | DQ <sub>8-15</sub> | DQ <sub>16-23</sub> | DQ <sub>24-31</sub> | Mode                             | Power              |
|----|-----|----|----|-----------------|-----------------|-----------------|-----------------|-------------------|--------------------|---------------------|---------------------|----------------------------------|--------------------|
| H  | X   | X  | X  | X               | X               | X               | X               | High-Z            | High-Z             | High-Z              | High-Z              | Power Down                       | (I <sub>SB</sub> ) |
| X  | L   | X  | X  | X               | X               | X               | X               | High-Z            | High-Z             | High-Z              | High-Z              | Power Down                       | (I <sub>SB</sub> ) |
| L  | H   | L  | H  | L               | L               | L               | L               | Data Out          | Data Out           | Data Out            | Data Out            | Read All Bits                    | (I <sub>CC</sub> ) |
| L  | H   | L  | H  | L               | H               | H               | H               | Data Out          | High-Z             | High-Z              | High-Z              | Read Byte a<br>Bits Only         | (I <sub>CC</sub> ) |
| L  | H   | L  | H  | H               | L               | H               | H               | High-Z            | Data Out           | High-Z              | High-Z              | Read Byte b<br>Bits Only         | (I <sub>CC</sub> ) |
| L  | H   | L  | H  | H               | H               | L               | H               | High-Z            | High-Z             | Data Out            | High-Z              | Read Byte c<br>Bits Only         | (I <sub>CC</sub> ) |
| L  | H   | L  | H  | H               | H               | H               | L               | High-Z            | High-Z             | High-Z              | Data Out            | Read Byte d<br>Bits Only         | (I <sub>CC</sub> ) |
| L  | H   | X  | L  | L               | L               | L               | L               | Data In           | Data In            | Data In             | Data In             | Write All Bits                   | (I <sub>CC</sub> ) |
| L  | H   | X  | L  | L               | H               | H               | H               | Data In           | High-Z             | High-Z              | High-Z              | Write Byte a<br>Bits Only        | (I <sub>CC</sub> ) |
| L  | H   | X  | L  | H               | L               | H               | H               | High-Z            | Data In            | High-Z              | High-Z              | Write Byte b<br>Bits Only        | (I <sub>CC</sub> ) |
| L  | H   | X  | L  | H               | H               | L               | H               | High-Z            | High-Z             | Data In             | High-Z              | Write Byte c<br>Bits Only        | (I <sub>CC</sub> ) |
| L  | H   | X  | L  | H               | H               | H               | L               | High-Z            | High-Z             | High-Z              | Data In             | Write Byte d<br>Bits Only        | (I <sub>CC</sub> ) |
| L  | H   | H  | H  | X               | X               | X               | X               | High-Z            | High-Z             | High-Z              | High-Z              | Selected,<br>Outputs<br>Disabled | (I <sub>CC</sub> ) |

## ABSOLUTE MAXIMUM RATINGS<sup>(1)</sup>

| Symbol            | Parameter                            | Value                         | Unit |
|-------------------|--------------------------------------|-------------------------------|------|
| V <sub>TERM</sub> | Terminal Voltage with Respect to GND | -0.5 to V <sub>DD</sub> + 0.5 | V    |
| V <sub>DD</sub>   | V <sub>DD</sub> Relates to GND       | -0.3 to 4.0                   | V    |
| T <sub>STG</sub>  | Storage Temperature                  | -65 to +150                   | °C   |
| P <sub>T</sub>    | Power Dissipation                    | 1.0                           | W    |

### Notes:

1. Stress greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## CAPACITANCE<sup>(1,2)</sup>

| Symbol           | Parameter                | Conditions            | Max. | Unit |
|------------------|--------------------------|-----------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance        | V <sub>IN</sub> = 0V  | 6    | pF   |
| C <sub>I/O</sub> | Input/Output Capacitance | V <sub>OUT</sub> = 0V | 8    | pF   |

### Notes:

1. Tested initially and after any design or process changes that may affect these parameters.
2. Test conditions: T<sub>A</sub> = 25°C, f = 1 MHz, V<sub>DD</sub> = 3.3V.

**DC ELECTRICAL CHARACTERISTICS** (Over Operating Range)

**V<sub>DD</sub> = 3.3V ± 5%**

| Symbol          | Parameter                        | Test Conditions   | Min. | Max.                  | Unit |
|-----------------|----------------------------------|---|------|-----------------------|------|
| V <sub>OH</sub> | Output HIGH Voltage              | V <sub>DD</sub> = Min., I <sub>OH</sub> = -4.0 mA           | 2.4  | —                     | V    |
| V <sub>OL</sub> | Output LOW Voltage               | V <sub>DD</sub> = Min., I <sub>OL</sub> = 8.0 mA            | —    | 0.4                   | V    |
| V <sub>IH</sub> | Input HIGH Voltage               |   | 2    | V <sub>DD</sub> + 0.3 | V    |
| V <sub>IL</sub> | Input LOW Voltage <sup>(1)</sup> |   | -0.3 | 0.8                   | V    |
| I <sub>LI</sub> | Input Leakage                    | GND ≤ V <sub>IN</sub> ≤ V <sub>DD</sub>                     | -1   | 1                     | μA   |
| I <sub>LO</sub> | Output Leakage                   | GND ≤ V <sub>OUT</sub> ≤ V <sub>DD</sub> , Outputs Disabled | -1   | 1                     | μA   |

**Note:**

- V<sub>IL</sub> (min.) = -0.3V DC; V<sub>IL</sub> (min.) = -2.0V AC (pulse width 2.0 ns). Not 100% tested.  
 V<sub>IH</sub> (max.) = V<sub>DD</sub> + 0.3V DC; V<sub>IH</sub> (max.) = V<sub>DD</sub> + 2.0V AC (pulse width 2.0 ns). Not 100% tested.

**DC ELECTRICAL CHARACTERISTICS** (Over Operating Range)

**V<sub>DD</sub> = 2.4V-3.6V**

| Symbol          | Parameter                        | Test Conditions   | Min. | Max.                  | Unit |
|-----------------|----------------------------------|---|------|-----------------------|------|
| V <sub>OH</sub> | Output HIGH Voltage              | V <sub>DD</sub> = Min., I <sub>OH</sub> = -1.0 mA           | 1.8  | —                     | V    |
| V <sub>OL</sub> | Output LOW Voltage               | V <sub>DD</sub> = Min., I <sub>OL</sub> = 1.0 mA            | —    | 0.4                   | V    |
| V <sub>IH</sub> | Input HIGH Voltage               |   | 2.0  | V <sub>DD</sub> + 0.3 | V    |
| V <sub>IL</sub> | Input LOW Voltage <sup>(1)</sup> |   | -0.3 | 0.8                   | V    |
| I <sub>LI</sub> | Input Leakage                    | GND ≤ V <sub>IN</sub> ≤ V <sub>DD</sub>                     | -1   | 1                     | μA   |
| I <sub>LO</sub> | Output Leakage                   | GND ≤ V <sub>OUT</sub> ≤ V <sub>DD</sub> , Outputs Disabled | -1   | 1                     | μA   |

**Note:**

- V<sub>IL</sub> (min.) = -0.3V DC; V<sub>IL</sub> (min.) = -2.0V AC (pulse width 2.0 ns). Not 100% tested.  
 V<sub>IH</sub> (max.) = V<sub>DD</sub> + 0.3V DC; V<sub>IH</sub> (max.) = V<sub>DD</sub> + 2.0V AC (pulse width 2.0 ns). Not 100% tested.

**DC ELECTRICAL CHARACTERISTICS** (Over Operating Range)

**V<sub>DD</sub> = 1.65V-2.2V**

| Symbol                         | Parameter           | Test Conditions   | V <sub>DD</sub> | Min. | Max.                  | Unit |
|--------------------------------|---------------------|---|-----------------|------|-----------------------|------|
| V <sub>OH</sub>                | Output HIGH Voltage | I <sub>OH</sub> = -0.1 mA                                   | 1.65-2.2V       | 1.4  | —                     | V    |
| V <sub>OL</sub>                | Output LOW Voltage  | I <sub>OL</sub> = 0.1 mA                                    | 1.65-2.2V       | —    | 0.2                   | V    |
| V <sub>IH</sub>                | Input HIGH Voltage  |   | 1.65-2.2V       | 1.4  | V <sub>DD</sub> + 0.2 | V    |
| V <sub>IL</sub> <sup>(1)</sup> | Input LOW Voltage   |   | 1.65-2.2V       | -0.2 | 0.4                   | V    |
| I <sub>LI</sub>                | Input Leakage       | GND ≤ V <sub>IN</sub> ≤ V <sub>DD</sub>                     |                 | -1   | 1                     | μA   |
| I <sub>LO</sub>                | Output Leakage      | GND ≤ V <sub>OUT</sub> ≤ V <sub>DD</sub> , Outputs Disabled |                 | -1   | 1                     | μA   |

**Notes:**

- V<sub>IL</sub> (min.) = -0.3V DC; V<sub>IL</sub> (min.) = -2.0V AC (pulse width -2.0ns). Not 100% tested.  
 V<sub>IH</sub> (max.) = V<sub>DD</sub> + 0.3V DC; V<sub>IH</sub> (max.) = V<sub>DD</sub> + 2.0V AC (pulse width -2.0ns). Not 100% tested.

## HIGH SPEED

### OPERATING RANGE (V<sub>DD</sub>) (IS61WV25632ALL)

| Range      | Ambient Temperature | V <sub>DD</sub> | Speed |
|------------|---------------------|-----------------|-------|
| Commercial | 0°C to +70°C        | 1.65V-2.2V      | 20ns  |
| Industrial | -40°C to +85°C      | 1.65V-2.2V      | 20ns  |
| Automotive | -40°C to +125°C     | 1.65V-2.2V      | 20ns  |

### OPERATING RANGE (V<sub>DD</sub>) (IS61WV25632BLL)<sup>(1)</sup>

| Range      | Ambient Temperature | V <sub>DD</sub> (8 ns) <sup>1</sup> | V <sub>DD</sub> (10 ns) <sup>1</sup> |
|------------|---------------------|-------------------------------------|--------------------------------------|
| Commercial | 0°C to +70°C        | 3.3V ± 5%                           | 2.4V-3.6V                            |
| Industrial | -40°C to +85°C      | 3.3V ± 5%                           | 2.4V-3.6V                            |

**Note:**

- When operated in the range of 2.4V-3.6V, the device meets 10ns. When operated in the range of 3.3V ± 5%, the device meets 8ns.

### OPERATING RANGE (V<sub>DD</sub>) (IS64WV25632BLL)

| Range      | Ambient Temperature | V <sub>DD</sub> (10 ns) |
|------------|---------------------|-------------------------|
| Automotive | -40°C to +125°C     | 2.4V-3.6V               |

### POWER SUPPLY CHARACTERISTICS<sup>(1)</sup> (Over Operating Range)

| Symbol           | Parameter  | Test Conditions  |                              | -8   |      | -10  |      | -20  |      | Unit |
|------------------|--|--|------------------------------|------|------|------|------|------|------|------|
|                  |  |  |                              | Min. | Max. | Min. | Max. | Min. | Max. |      |
| I <sub>CC</sub>  | V <sub>DD</sub> Dynamic Operating Supply Current | V <sub>DD</sub> = Max.,<br>I <sub>OUT</sub> = 0 mA, f = f <sub>MAX</sub>   | Com.                         | —    | 110  | —    | 90   | —    | 50   | mA   |
|                  |  |  | Ind.                         | —    | 115  | —    | 95   | —    | 60   |      |
|                  |  |  | Auto.<br>typ. <sup>(2)</sup> | —    | —    | —    | 140  | —    | 100  |      |
| I <sub>CC1</sub> | Operating Supply Current                         | V <sub>DD</sub> = Max.,<br>I <sub>OUT</sub> = 0 mA, f = 0  | Com.                         | —    | 85   | —    | 85   | —    | 45   | mA   |
|                  |  |  | Ind.                         | —    | 90   | —    | 90   | —    | 55   |      |
|                  |  |  | Auto.                        | —    | —    | —    | 110  | —    | 90   |      |
| I <sub>SB1</sub> | TTL Standby Current (TTL Inputs)                 | V <sub>DD</sub> = Max.,<br>V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>CE ≥ V <sub>IH</sub> , f = 0                          | Com.                         | —    | 30   | —    | 30   | —    | 30   | mA   |
|                  |  |  | Ind.                         | —    | 35   | —    | 35   | —    | 35   |      |
|                  |  |  | Auto.                        | —    | —    | —    | 70   | —    | 70   |      |
| I <sub>SB2</sub> | CMOS Standby Current (CMOS Inputs)               | V <sub>DD</sub> = Max.,<br>CE ≥ V <sub>DD</sub> - 0.2V,<br>V <sub>IN</sub> ≥ V <sub>DD</sub> - 0.2V, or<br>V <sub>IN</sub> ≤ 0.2V, f = 0 | Com.                         | —    | 20   | —    | 20   | —    | 20   | mA   |
|                  |  |  | Ind.                         | —    | 25   | —    | 25   | —    | 25   |      |
|                  |  |  | Auto.<br>typ. <sup>(2)</sup> | —    | —    | —    | 60   | —    | 60   |      |
|                  |  |  |                              |      |      |      |      |      |      | 4    |

**Note:**

- At f = f<sub>MAX</sub>, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.
- Typical values are measured at V<sub>DD</sub> = 3.0V, T<sub>A</sub> = 25°C and not 100% tested.

## LOW POWER

### OPERATING RANGE (V<sub>DD</sub>) (IS61WV25632ALS)

| Range      | Ambient Temperature | V <sub>DD</sub> | Speed |
|------------|---------------------|-----------------|-------|
| Commercial | 0°C to +70°C        | 1.65V-2.2V      | 35ns  |
| Industrial | -40°C to +85°C      | 1.65V-2.2V      | 35ns  |
| Automotive | -40°C to +125°C     | 1.65V-2.2V      | 35ns  |

### OPERATING RANGE (V<sub>DD</sub>) (IS61WV25632BLS)<sup>(1)</sup>

| Range      | Ambient Temperature | V <sub>DD</sub> (25 ns) <sup>1</sup> |
|------------|---------------------|--------------------------------------|
| Commercial | 0°C to +70°C        | 2.4V-3.6V                            |
| Industrial | -40°C to +85°C      | 2.4V-3.6V                            |

**Note:**

- When operated in the range of 2.4V-3.6V, the device meets 25ns. When operated in the range of 3.3V ± 5%, the device meets 20ns.

### POWER SUPPLY CHARACTERISTICS<sup>(1)</sup> (Over Operating Range)

| Symbol           | Parameter  | Test Conditions  |                     | -25  |      | -35  |      | Unit |
|------------------|--|--|---------------------|------|------|------|------|------|
|                  |  |  |                     | Min. | Max. | Min. | Max. |      |
| I <sub>CC</sub>  | V <sub>DD</sub> Dynamic Operating Supply Current | V <sub>DD</sub> = Max.,<br>I <sub>OUT</sub> = 0 mA, f = f <sub>MAX</sub>   | Com.                | —    | 30   | —    | 25   | mA   |
|                  |  |  | Ind.                | —    | 35   | —    | 30   |      |
|                  |  |  | Auto.               | —    | 60   | —    | 60   |      |
|                  |  |  | typ. <sup>(2)</sup> | 25   |      |      |      |      |
| I <sub>CC1</sub> | Operating Supply Current                         | V <sub>DD</sub> = Max.,<br>I <sub>OUT</sub> = 0 mA, f = 0  | Com.                | —    | 20   | —    | 20   | mA   |
|                  |  |  | Ind.                | —    | 30   | —    | 30   |      |
|                  |  |  | Auto.               | —    | 50   | —    | 50   |      |
| I <sub>SB1</sub> | TTL Standby Current (TTL Inputs)                 | V <sub>DD</sub> = Max.,<br>V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub><br>CE ≥ V <sub>IH</sub> , f = 0                          | Com.                | —    | 15   | —    | 15   | mA   |
|                  |  |  | Ind.                | —    | 20   | —    | 20   |      |
|                  |  |  | Auto.               | —    | 40   | —    | 40   |      |
| I <sub>SB2</sub> | CMOS Standby Current (CMOS Inputs)               | V <sub>DD</sub> = Max.,<br>CE ≥ V <sub>DD</sub> - 0.2V,<br>V <sub>IN</sub> ≥ V <sub>DD</sub> - 0.2V, or<br>V <sub>IN</sub> ≤ 0.2V, f = 0 | Com.                | —    | 0.8  | —    | 0.8  | mA   |
|                  |  |  | Ind.                | —    | 1.2  | —    | 1.2  |      |
|                  |  |  | Auto.               | —    | 2    | —    | 2    |      |
|                  |  |  | typ. <sup>(2)</sup> | 0.1  |      | 0.1  |      |      |

**Note:**

- At f = f<sub>MAX</sub>, address and data inputs are cycling at the maximum frequency, f = 0 means no input lines change.
- Typical values are measured at V<sub>DD</sub> = 3.0V, T<sub>A</sub> = 25°C and not 100% tested.

### AC TEST CONDITIONS (HIGH SPEED)

| Parameter   | Unit<br>(2.4V-3.6V)   | Unit<br>(3.3V ± 5%)   | Unit<br>(1.65V-2.2V)  |
|---|-----------------------|-----------------------|-----------------------|
| Input Pulse Level   | 0.4V to $V_{DD}-0.3V$ | 0.4V to $V_{DD}-0.3V$ | 0.4V to $V_{DD}-0.2V$ |
| Input Rise and Fall Times                                 | 1.5ns                 | 1.5ns                 | 1.5ns                 |
| Input and Output Timing and Reference Level ( $V_{Ref}$ ) | $V_{DD}/2$            | $V_{DD}/2 + 0.05$     | $V_{DD}/2$            |
| Output Load   | See Figures 1 and 2   | See Figures 1 and 2   | See Figures 1 and 2   |

### AC TEST LOADS

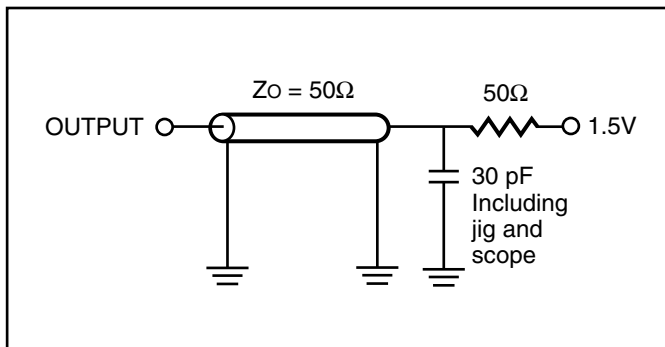


Figure 1.

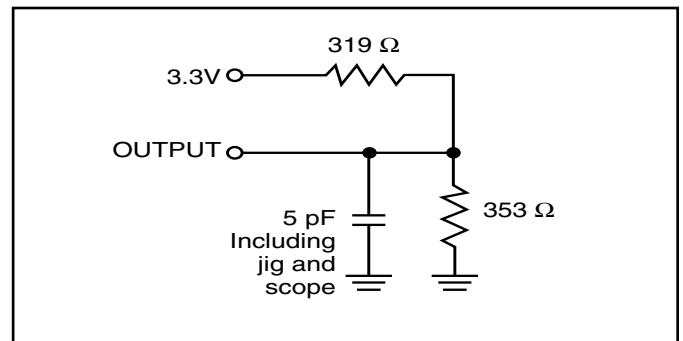


Figure 2.

**READ CYCLE SWITCHING CHARACTERISTICS<sup>(1)</sup>** (Over Operating Range)

| Symbol                          | Parameter                        | -8   |      | -10  |      | Unit |
|---------------------------------|----------------------------------|------|------|------|------|------|
|                                 |                                  | Min. | Max. | Min. | Max. |      |
| t <sub>RC</sub>                 | Read Cycle Time                  | 8    | —    | 10   | —    | ns   |
| t <sub>AA</sub>                 | Address Access Time              | —    | 8    | —    | 10   | ns   |
| t <sub>OHA</sub>                | Output Hold Time                 | 2.5  | —    | 2.5  | —    | ns   |
| t <sub>ACE</sub>                | $\overline{CE}$ Access Time      | —    | 8    | —    | 10   | ns   |
| t <sub>DOE</sub>                | $\overline{OE}$ Access Time      | —    | 5.5  | —    | 6.5  | ns   |
| t <sub>HZOE<sup>(2)</sup></sub> | $\overline{OE}$ to High-Z Output | —    | 3    | —    | 4    | ns   |
| t <sub>LZOE<sup>(2)</sup></sub> | $\overline{OE}$ to Low-Z Output  | 0    | —    | 0    | —    | ns   |
| t <sub>HZCE<sup>(2)</sup></sub> | $\overline{CE}$ to High-Z Output | 0    | 3    | 0    | 4    | ns   |
| t <sub>LZCE<sup>(2)</sup></sub> | $\overline{CE}$ to Low-Z Output  | 3    | —    | 3    | —    | ns   |
| t <sub>BA</sub>                 | Byte Enable to Data Valid        | —    | 5.5  | —    | 6.5  | ns   |
| t <sub>LZB</sub>                | Byte Enable to Low-Z             | 0    | —    | 0    | —    | ns   |
| t <sub>HZB</sub>                | Byte Enable to High-Z            | 0    | 3    | 0    | 3    | ns   |

**Notes:**

1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0V to 3.0V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured  $\pm 500$  mV from steady-state voltage.



**READ CYCLE SWITCHING CHARACTERISTICS<sup>(1)</sup>** (Over Operating Range)

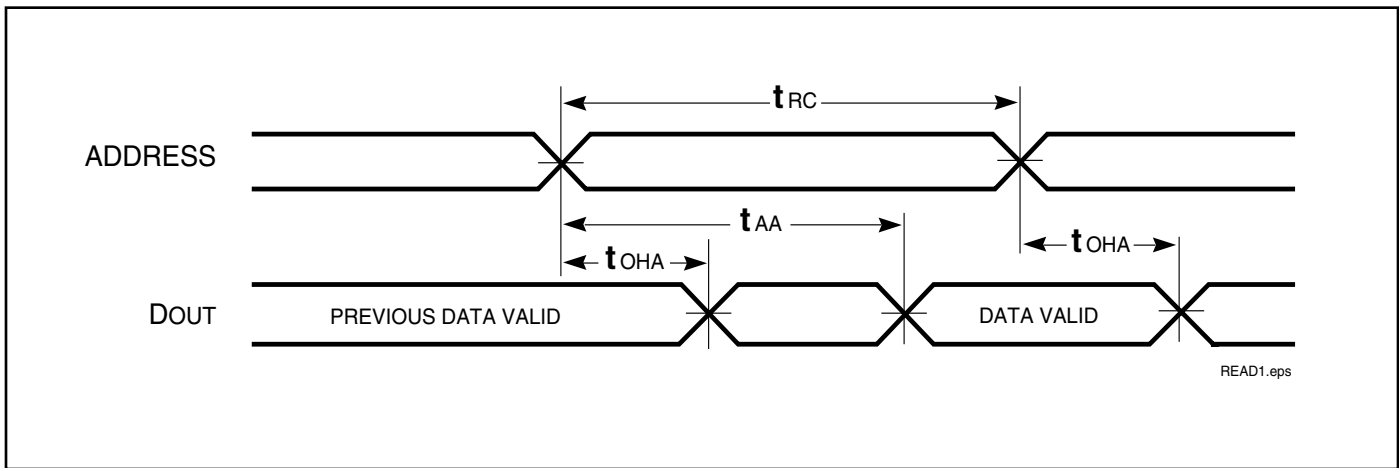
| Symbol                          | Parameter                 | -20 ns |      | Unit |
|---------------------------------|---------------------------|--------|------|------|
|                                 |                           | Min.   | Max. |      |
| t <sub>RC</sub>                 | Read Cycle Time           | 20     | —    | ns   |
| t <sub>AA</sub>                 | Address Access Time       | —      | 20   | ns   |
| t <sub>OHA</sub>                | Output Hold Time          | 2.5    | —    | ns   |
| t <sub>ACE</sub>                | CE Access Time            | —      | 20   | ns   |
| t <sub>DOE</sub>                | OE Access Time            | —      | 8    | ns   |
| t <sub>HZOE<sup>(2)</sup></sub> | OE to High-Z Output       | 0      | 8    | ns   |
| t <sub>LZOE<sup>(2)</sup></sub> | OE to Low-Z Output        | 0      | —    | ns   |
| t <sub>HZCE<sup>(2)</sup></sub> | CE to High-Z Output       | 0      | 8    | ns   |
| t <sub>LZCE<sup>(2)</sup></sub> | CE to Low-Z Output        | 3      | —    | ns   |
| t <sub>BA</sub>                 | Byte Enable to Data Valid | —      | 8    | ns   |
| t <sub>LZB</sub>                | Byte Enable to Low-Z      | 0      | —    | ns   |
| t <sub>HZB</sub>                | Byte Enable to High-Z     | 0      | 3    | ns   |

**Notes:**

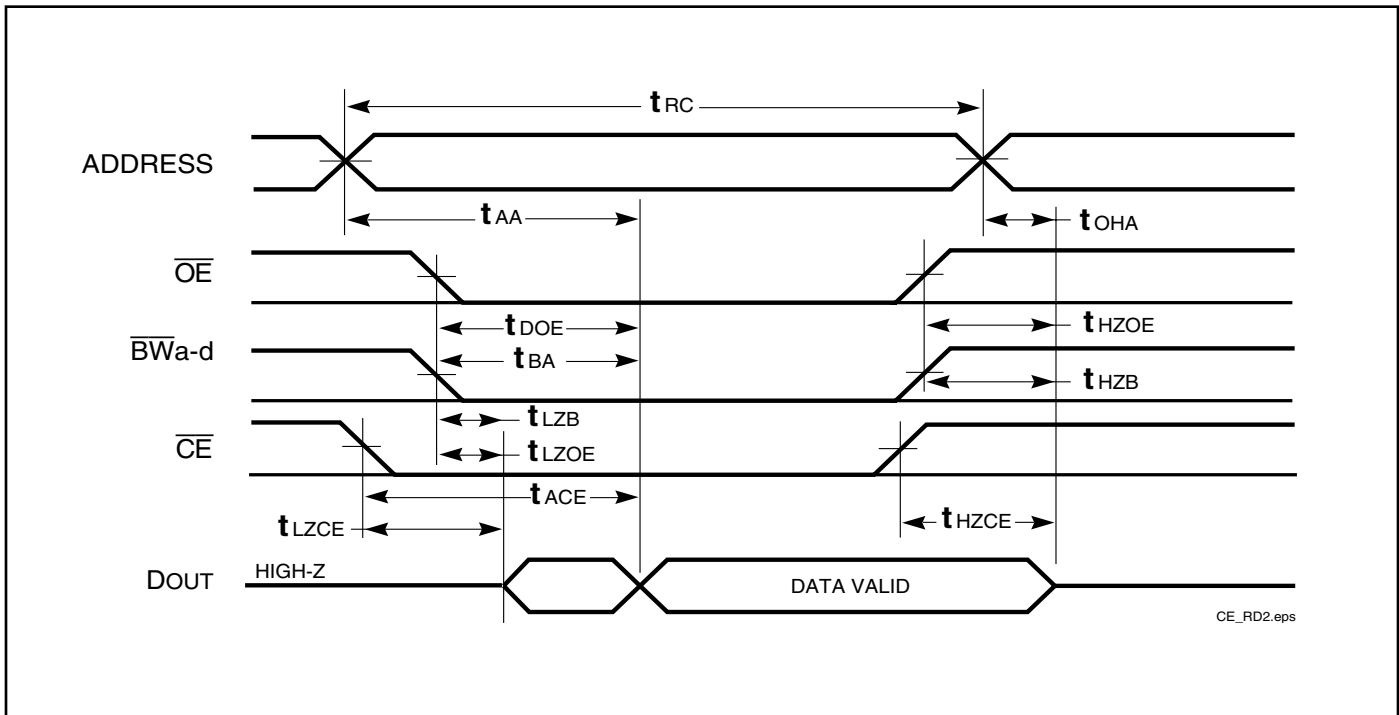
1. Test conditions assume signal transition times of 1.5 ns or less, timing reference levels of 1.25V, input pulse levels of 0.4V to V<sub>DD</sub>-0.3V and output loading specified in Figure 1a.
2. Tested with the load in Figure 1b. Transition is measured ±500 mV from steady-state voltage. Not 100% tested.
3. Not 100% tested.

**AC WAVEFORMS**

**READ CYCLE NO. 1<sup>(1,2)</sup>** ( $\overline{CE} = \overline{OE} = V_{IL}$ )



**READ CYCLE NO. 2<sup>(1,3)</sup>** ( $\overline{CE}$  and  $\overline{OE}$  Controlled)



**Notes:**

1.  $\overline{WE}$  is HIGH for a Read Cycle.
2. The device is continuously selected.  $\overline{OE}$ ,  $\overline{CE} = V_{IL}$ .
3. Address is valid prior to or coincident with  $\overline{CE}$  LOW transitions.

**WRITE CYCLE SWITCHING CHARACTERISTICS<sup>(1,3)</sup>** (Over Operating Range)

| Symbol                          | Parameter  | -8   |      | -10  |      | Unit |
|---------------------------------|--|------|------|------|------|------|
|                                 |  | Min. | Max. | Min. | Max. |      |
| t <sub>WC</sub>                 | Write Cycle Time                                     | 8    | —    | 10   | —    | ns   |
| t <sub>SCE</sub>                | $\overline{CE}$ to Write End                         | 6.5  | —    | 8    | —    | ns   |
| t <sub>AW</sub>                 | Address Setup Time to Write End                      | 6.5  | —    | 8    | —    | ns   |
| t <sub>HA</sub>                 | Address Hold from Write End                          | 0    | —    | 0    | —    | ns   |
| t <sub>SA</sub>                 | Address Setup Time                                   | 0    | —    | 0    | —    | ns   |
| t <sub>PWB</sub>                | $\overline{BWA}$ -d Valid to End of Write            | 6.5  | —    | 8    | —    | ns   |
| t <sub>PWE1</sub>               | $\overline{WE}$ Pulse Width                          | 6.5  | —    | 8    | —    | ns   |
| t <sub>PWE2</sub>               | $\overline{WE}$ Pulse Width ( $\overline{OE}$ = LOW) | 8.0  | —    | 10   | —    | ns   |
| t <sub>SD</sub>                 | Data Setup to Write End                              | 5    | —    | 6    | —    | ns   |
| t <sub>HD</sub>                 | Data Hold from Write End                             | 0    | —    | 0    | —    | ns   |
| t <sub>HZWE<sup>(2)</sup></sub> | $\overline{WE}$ LOW to High-Z Output                 | —    | 3.5  | —    | 5    | ns   |
| t <sub>LZWE<sup>(2)</sup></sub> | $\overline{WE}$ HIGH to Low-Z Output                 | 2    | —    | 2    | —    | ns   |

**Notes:**

1. Test conditions assume signal transition times of 3 ns or less, timing reference levels of 1.5V, input pulse levels of 0V to 3.0V and output loading specified in Figure 1.
2. Tested with the load in Figure 2. Transition is measured  $\pm 500$  mV from steady-state voltage. Not 100% tested.
3. The internal write time is defined by the overlap of  $\overline{CE}$  LOW, and  $\overline{WE}$  LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write. Shaded area product in development

**WRITE CYCLE SWITCHING CHARACTERISTICS<sup>(1,2)</sup>** (Over Operating Range)

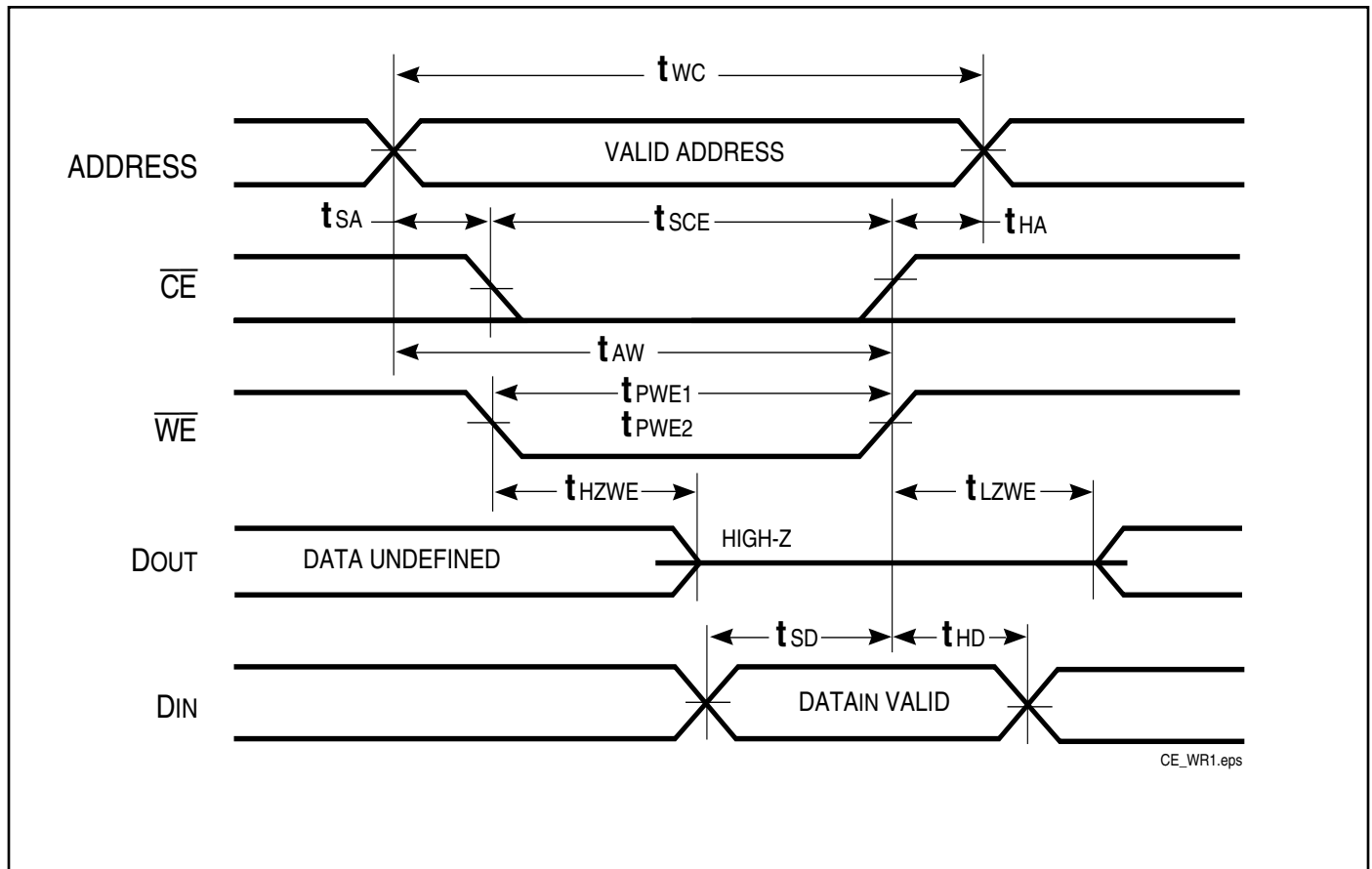
| Symbol                          | Parameter   | -20 ns |      | Unit |
|---------------------------------|---|--------|------|------|
|                                 |   | Min.   | Max. |      |
| t <sub>WC</sub>                 | Write Cycle Time                                      | 20     | —    | ns   |
| t <sub>SCE</sub>                | $\overline{CE}$ to Write End                          | 12     | —    | ns   |
| t <sub>AW</sub>                 | Address Setup Time to Write End                       | 12     | —    | ns   |
| t <sub>HA</sub>                 | Address Hold from Write End                           | 0      | —    | ns   |
| t <sub>SA</sub>                 | Address Setup Time                                    | 0      | —    | ns   |
| t <sub>PWB</sub>                | $\overline{BWA}$ -d Valid to End of Write             | 12     | —    | ns   |
| t <sub>PWE1</sub>               | $\overline{WE}$ Pulse Width ( $\overline{OE}$ = HIGH) | 12     | —    | ns   |
| t <sub>PWE2</sub>               | $\overline{WE}$ Pulse Width ( $\overline{OE}$ = LOW)  | 17     | —    | ns   |
| t <sub>SD</sub>                 | Data Setup to Write End                               | 9      | —    | ns   |
| t <sub>HD</sub>                 | Data Hold from Write End                              | 0      | —    | ns   |
| t <sub>HZWE<sup>(3)</sup></sub> | $\overline{WE}$ LOW to High-Z Output                  | —      | 9    | ns   |
| t <sub>LZWE<sup>(3)</sup></sub> | $\overline{WE}$ HIGH to Low-Z Output                  | 3      | —    | ns   |

**Notes:**

1. Test conditions assume signal transition times of 3ns or less, timing reference levels of 1.5V, input pulse levels of 0V to 0.3V and output loading specified in Figure 1a.
2. Tested with the load in Figure 1b. Transition is measured  $\pm 500$  mV from steady-state voltage. Not 100% tested.
3. The internal write time is defined by the overlap of  $\overline{CE}$  LOW and  $\overline{WE}$  LOW. All signals must be in valid states to initiate a Write, but any one can go inactive to terminate the Write. The Data Input Setup and Hold timing are referenced to the rising or falling edge of the signal that terminates the write.

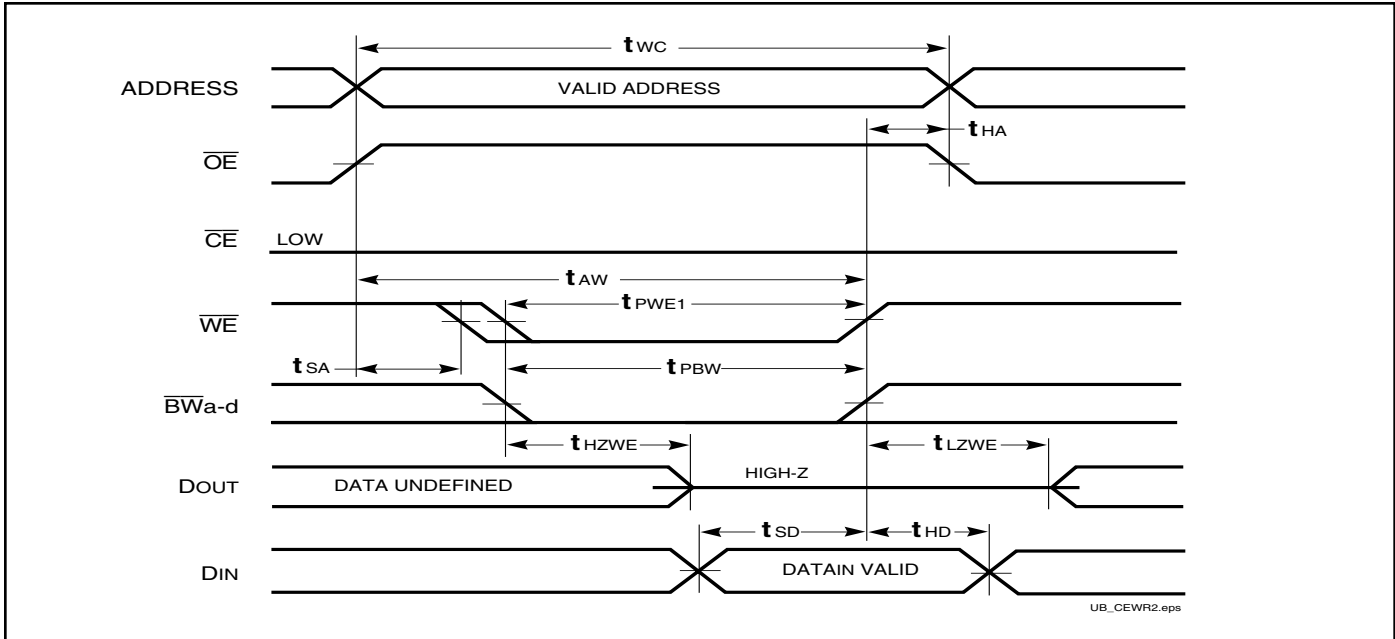
**AC WAVEFORMS**

**WRITE CYCLE NO. 1**<sup>(1,2)</sup> ( $\overline{CE}$  Controlled,  $\overline{OE}$  = HIGH or LOW)

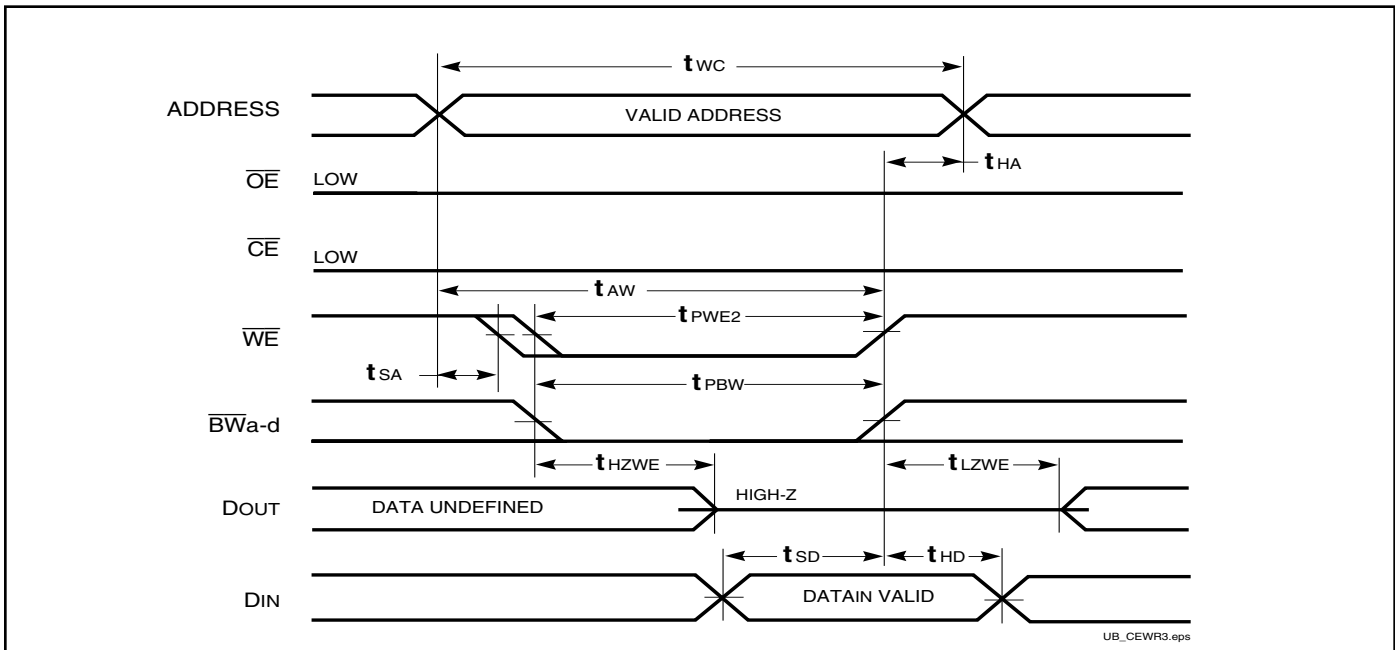


**AC WAVEFORMS**

**WRITE CYCLE NO. 2** ( $\overline{WE}$  Controlled.  $\overline{OE}$  is HIGH During Write Cycle) <sup>(1,2)</sup>

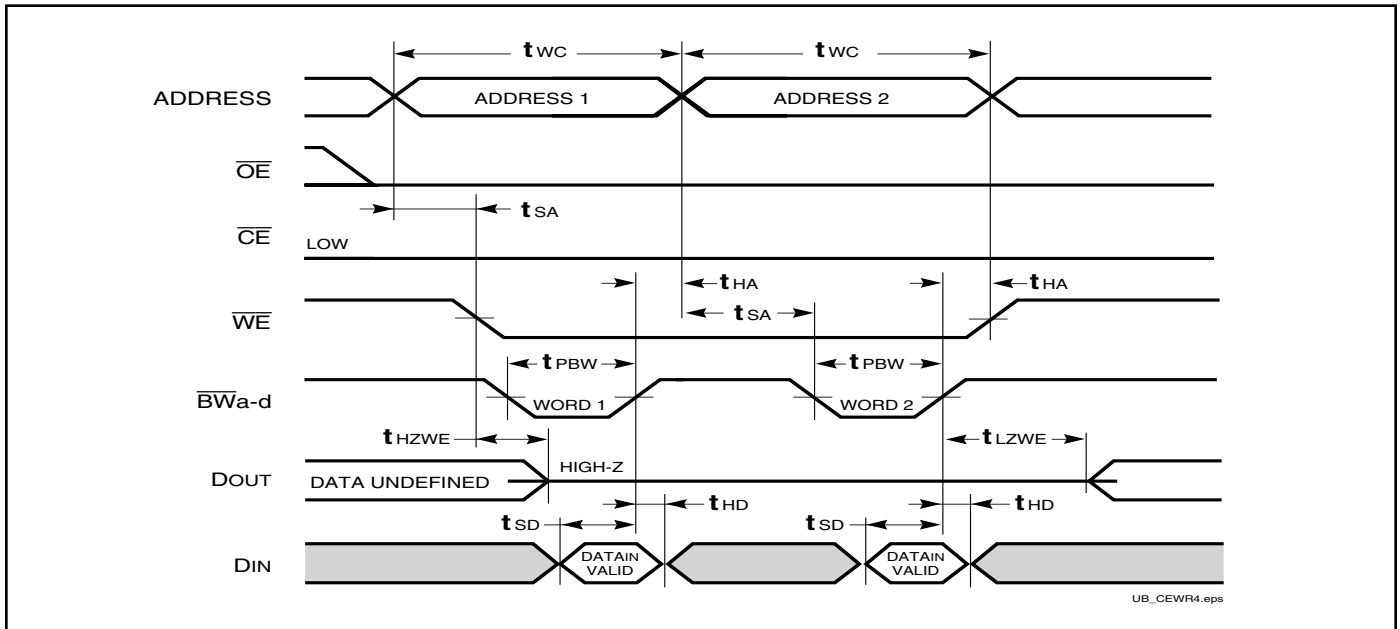


**WRITE CYCLE NO. 3** ( $\overline{WE}$  Controlled.  $\overline{OE}$  is LOW During Write Cycle) <sup>(1)</sup>



## AC WAVEFORMS

### WRITE CYCLE NO. 4 (Byte Controlled, Back-to-Back Write) <sup>(1,3)</sup>



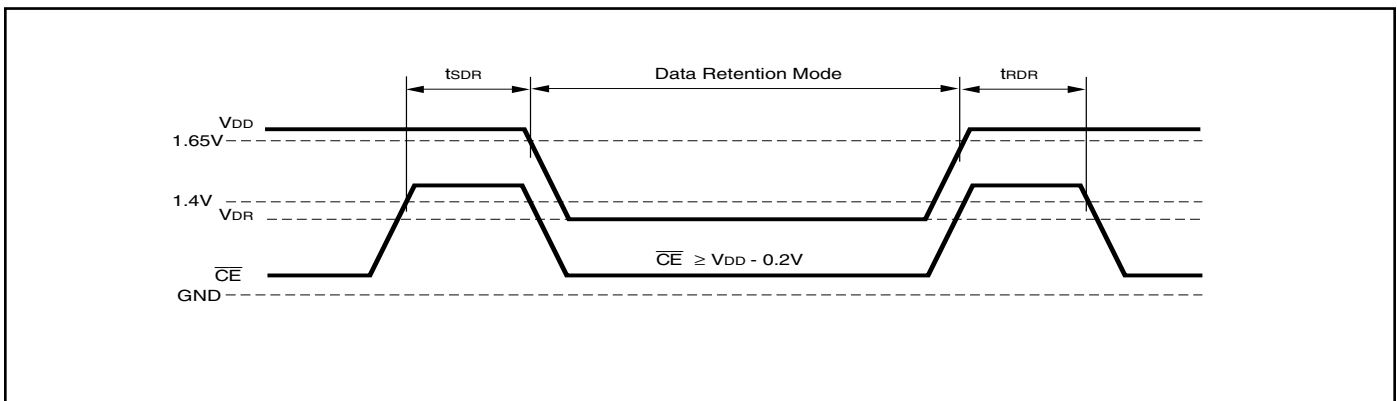
#### Notes:

1. The internal Write time is defined by the overlap of  $\overline{WE} = \text{LOW}$ . All signals must be in valid states to initiate a Write, but any can be deasserted to terminate the Write. The  $t_{SA}$ ,  $t_{HA}$ ,  $t_{SD}$ , and  $t_{HD}$  timing is referenced to the rising or falling edge of the signal that terminates the Write.
2. Tested with  $\overline{OE}$  HIGH for a minimum of 4 ns before  $\overline{WE} = \text{LOW}$  to place the I/O in a HIGH-Z state.

**DATA RETENTION SWITCHING CHARACTERISTICS (HIGH SPEED) (IS61WV25632ALL/BLL)**

| Symbol    | Parameter                   | Test Condition                                    | Min.     | Max.     | Unit                |
|-----------|-----------------------------|---|----------|----------|---------------------|
| $V_{DR}$  | $V_{DD}$ for Data Retention | See Data Retention Waveform                       | 1.2      | 3.6      | V                   |
| $I_{DR}$  | Data Retention Current      | $V_{DD} = 1.2V, \overline{CE} \geq V_{DD} - 0.2V$ | —        | 25<br>60 | mA<br>Ind.<br>Auto. |
| $t_{SDR}$ | Data Retention Setup Time   | See Data Retention Waveform                       | 0        | —        | ns                  |
| $t_{RDR}$ | Recovery Time               | See Data Retention Waveform                       | $t_{RC}$ | —        | ns                  |

**DATA RETENTION WAVEFORM ( $\overline{CE}$  Controlled)**

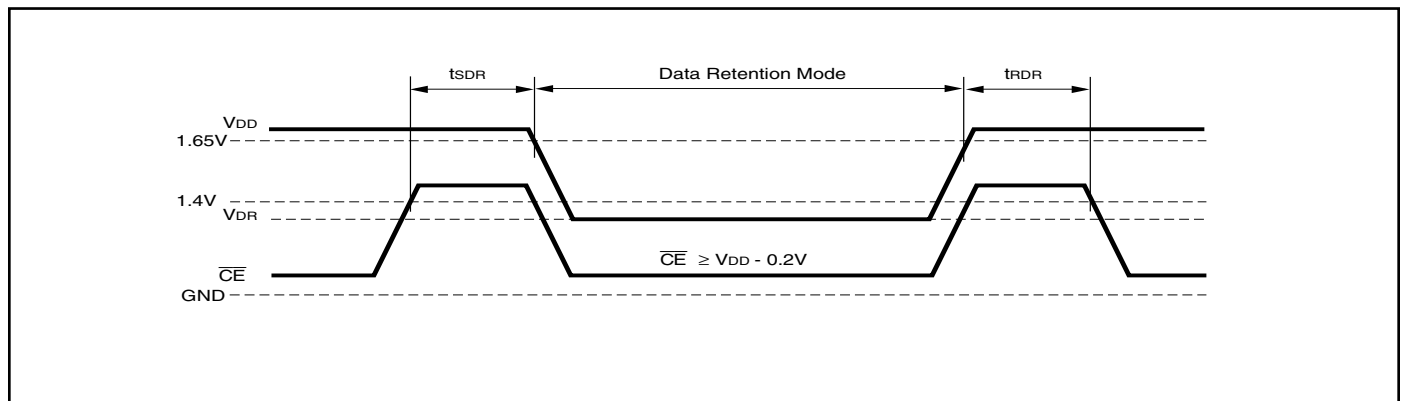




**DATA RETENTION SWITCHING CHARACTERISTICS (LOW POWER) (IS61WV25632ALS/BLS)**

| Symbol    | Parameter                   | Test Condition                                    | Min.          | Max.   | Unit |
|-----------|-----------------------------|---|---------------|--------|------|
| $V_{DR}$  | $V_{DD}$ for Data Retention | See Data Retention Waveform                       | 1.2           | 3.6    | V    |
| $I_{DR}$  | Data Retention Current      | $V_{DD} = 1.2V, \overline{CE} \geq V_{DD} - 0.2V$ | Ind.<br>Auto. | —<br>2 | mA   |
| $t_{SDR}$ | Data Retention Setup Time   | See Data Retention Waveform                       | 0             | —      | ns   |
| $t_{RDR}$ | Recovery Time               | See Data Retention Waveform                       | $t_{RC}$      | —      | ns   |

**DATA RETENTION WAVEFORM ( $\overline{CE}$  Controlled)**



## ORDERING INFORMATION

**Industrial Range: -40°C to +85°C**

**Voltage Range: 2.4V to 3.6V**

| Speed (ns)           | Order Part No.       | Package                             |
|----------------------|----------------------|-------------------------------------|
| 10 (8 <sup>1</sup> ) | IS61WV25632BLL-10BI  | 90-ball BGA (8mm x 13mm)            |
|                      | IS61WV25632BLL-10BLI | 90-ball BGA (8mm x 13mm), Lead-free |

Note:

1. Speed = 8ns for  $V_{DD} = 3.3V \pm 5\%$ . Speed = 10ns for  $V_{DD} = 2.4V - 3.6V$

**Industrial Range: -40°C to +85°C**

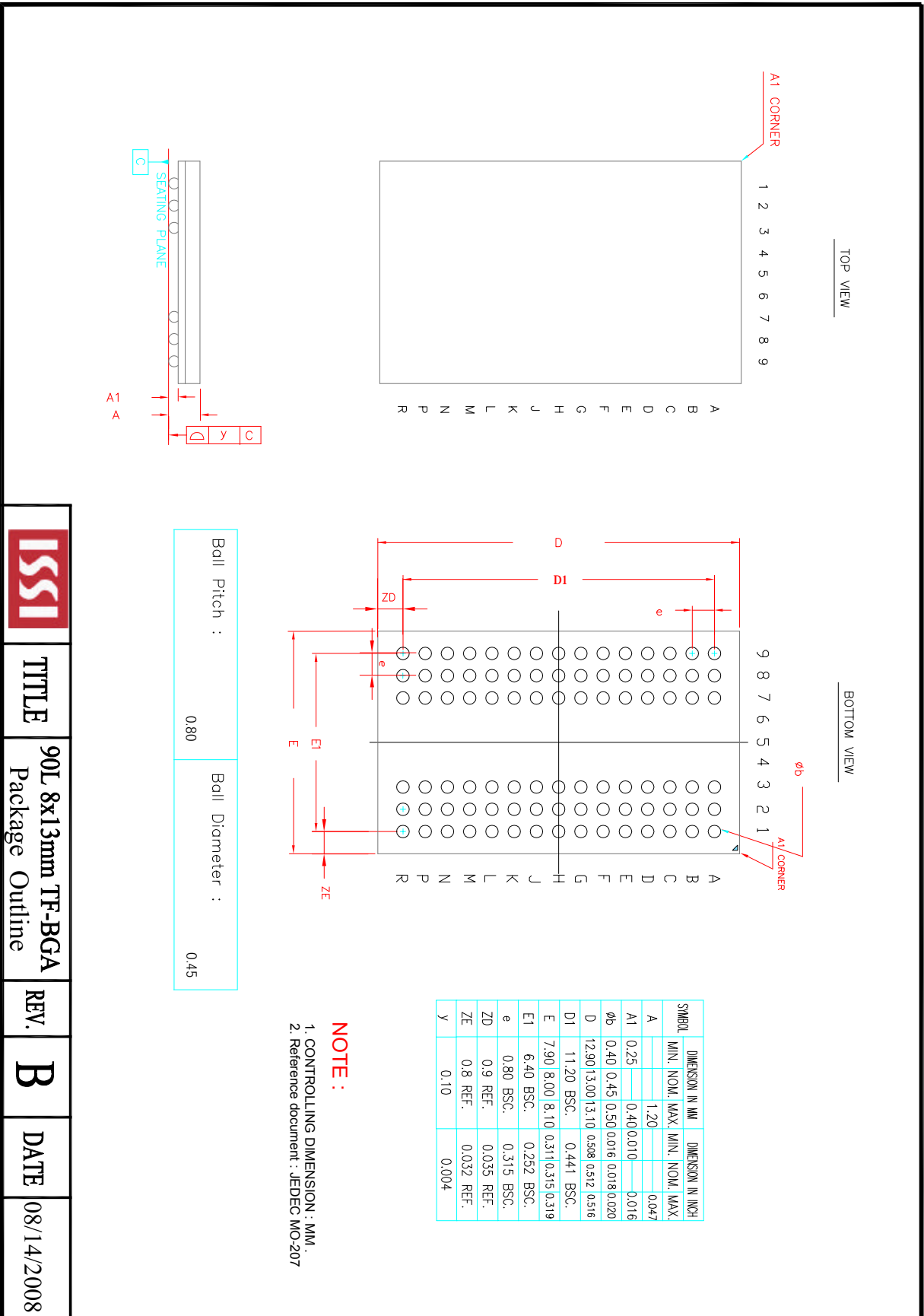
**Voltage Range: 1.65V to 2.2V**

| Speed (ns) | Order Part No.      | Package                  |
|------------|---------------------|--------------------------|
| 20         | IS61WV25632ALL-20BI | 90-ball BGA (8mm x 13mm) |

**Automotive Range: -40°C to +125°C**

**Voltage Range: 2.4V to 3.6V**

| Speed (ns) | Order Part No.       | Package                  |
|------------|----------------------|--------------------------|
| 10         | IS64WV25632BLL-10BA3 | 90-ball BGA (8mm x 13mm) |



|  |                                   |             |             |
|--|-----------------------------------|-------------|-------------|
|  | <b>TITLE</b>                      | <b>REV.</b> | <b>DATE</b> |
|  | 90L 8x13mm TF-BGA Package Outline | B           | 08/14/2008  |



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

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